- X-ray Diffraction
- applied to the study of polycrystalline materials

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PROGRAMME

Part I

- Powder Diffraction and reciprocal lattice
- Diffraction: theoretical elements

Part II

 Applications of powder diffraction: a survey

Part III

 Introduction to line profile analysis for the study of nanocrystalline and heavily deformed materials



DIFFRACTION LINE BROADENING



What information can be obtained on

nanocrystalline and heavily deformed materials?

What is the origin of the Line Broadening effect?



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Most common sources of line broadening

- crystalline domain size and shape (and distribution)
- generalised line defects, e.g., dislocations, disclinations
- planar faults, e.g., twin and deformation faults
- anti-phase domain boundaries (in ordered phases)
- residual (micro)strain (e.g. by misfitting inclusions)
- grain surface effects (e.g. grain surface relaxation)
- lattice parameter fluctuation from grain to grain (e.g. impurities)



DIFFRACTION LINE BROADENING

Origin of diffraction line broadening



The reciprocal space is made of points (representing families of *hkl* planes). Formally this is true only for *perfect* crystals, i.e., infinite crystals with no defects (e.g. no surface) to interrupt the coherency of the crystalline lattice





For a *perfect* (*infinite*) crystal, peak width is determined only by the instrumental resolution







For a *finite crystal (D<1mm)* point size is finite (measurable), and it increases by decreasing the crystalline domain size







Point shape is related (reciprocal) to the shape of the crystallite. The intensity varies across the point, and for a cubic crystal it follows the the trend of the *interference function*:





For hk0 lines, N=8:

$$I \propto \left|F_{T}\right|^{2} \frac{\sin^{2}(pNh)}{(ph)^{2}} \frac{\sin^{2}(pNk)}{(pk)^{2}}$$





When approaching the Bragg condition the sphere starts crossing the points.

The intensity measured between q and q+dq is proportional to the intensity between d* and d*+dd*

Point spreads over a region much smaller than d*: integration over the spherical surfaces can be replaced by integration over tangent planes



The peak profile in a powder pattern is given by the integral of the intensity in the reciprocal space over the sphere of radius d^* (approximated by the tangent plane).

The integration depends on: (a) *shape* of the 'point' (i.e., of the crystallite) and (b) *direction* along which the point is crossed (related to the Miller indices for the given peak).



In the simple case shown below ((001) peak, cubic crystallite, edge D)

$$I \propto \left|F_{T}\right|^{2} \iint \frac{\sin^{2}(pNh)}{\left(ph\right)^{2}} \frac{\sin^{2}(pNk)}{\left(pk\right)^{2}} \frac{\sin^{2}(pNl)}{\left(pl\right)^{2}} dh \cdot dk \rightarrow \left|F_{T}\right|^{2} \frac{\sin^{2}(pNl)}{\left(pl\right)^{2}} dh \cdot dk$$



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For any other crystallite shape and (hkl) reflections the result is different. The intergal breadth is in any case inversely proportional to the domain size, but a geometrical coefficient (*Scherrer constant*) must be calculated for each specific case.





For a powder made of spherical crystallites of diameter D, the Scherrer constant is the same for any (hkl):

$$b(d^*) = \frac{4}{3D}$$
 $\frac{4}{3}$ Scherrer constant for sphere

In general, for crystallites with simple shapes (convex solids like spheres, cubes, octhaedra, tetrahedra, ...)

$$b\left(d^*\right) = \frac{K_b}{D}$$

where K_b is the Scherrer constant (for the integral breadth), different for the various crystallite shapes and for different (hkl)

 $[h_1k_1l_1]$

 $[h_2k_2l_2]$



DOMAIN SIZE BROADENING

If the powder is made of a *distribution* g(D) of crystallites (with same shape) of volume $V_c(D)$, the diffracted profile is a weighted average of the intensity from a single crystallite (I_c) :



e.g., lognormal distributions à

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As a consequence, features of the profile of a single crystallite are 'embedded' in the overall profile for the dispersed system.

 $b\left(d_{hkl}^{*}\right) = K_{b} \frac{\overline{M}_{3}}{M_{4}} = \frac{K_{b}}{\langle D \rangle}$



(<u>a</u>)'6

If a size distribution is present (polydisperse system), the integral breadth gives an average size <D> given by:

where M_3 and M_4 are the 3° and 4° moments of g(D)

 $I(d^*)$

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D

– μ=2, σ=0.1 – μ=2, σ=0.2 – μ=2, σ=0.3

- u=2. σ=0.5



MICROSTRAIN EFFECT IN POWDER DIFFRACTION

The distortion effect of lattice defects (dislocations, faulting, inclusions, etc), is quite complex. The effect of a lattice deformation can modify both the position and the width and shape of the reciprocal space points. Differently from the 'size' effect, the 'strain' effect *depends on d**





MACROSTRAIN EFFECT

By using an euristic approach, differentiating the Bragg law (with λ = constant) one can demonstrate that

 $0 = 2\Delta d \sin(q) + 2d \cos(q) \Delta(q)$

Introducing the strain: $e = \Delta d/d$

 $\Delta(2q) = -2\tan(q)\frac{\Delta d}{d} = -2e\tan(q)$



MACROSTRAIN EFFECT

The presence of a uniform strain, produces a *shift* in the position of the diffraction peaks — *Residual strain/stress analysis*



MICROSTRAIN EFFECT IN POWDER DIFFRACTION

If a non-uniform strain is present, then a microstrain (r.m.s. strain) must be considered $\langle e^2 \rangle^{1/2} = \langle (\Delta d/d)^2 \rangle^{1/2}$ which is related to a strain distribution $p_L(e)$ (whose mean can also be zero)

 $b(2q) \approx 2\langle e^2 \rangle^{1/2} \tan q$





COMBINED 'SIZE-STRAIN' EFFECT

If the combined effect is considered – domain size and lattice distortions – then one can write (as a first order approximation):





DIFFRACTION LINE BROADENING

Traditional methods of line profile analysis



INTEGRAL BREADTH METHODS

Line profile information can be represented by the integral breadth (β =peak area/peak maximum). If only 'size' effects are considered, then:





INTEGRAL BREADTH METHODS





INTEGRAL BREADTH METHODS

The method is simple and easy to apply, even if it is based on quite simplified hypotheses (e.g., the additivity of the two terms). Results are mostly to be considered as qualitative.





FOURIER METHODS

The PD profile is a convolution (2) of profile components produced by different sources: instrumental profile (IP), domain size (S), microstrain (D), faulting (F), anti-phase domain boundaries (APB), stoichiometry fluctuations (C), grain surface relaxation (GSR), etc.

 $I\left(d^{*}\right) = I^{IP}\left(d^{*}\right) \otimes I^{S}\left(d^{*}\right) \otimes I^{D}\left(d^{*}\right) \otimes I^{F}\left(d^{*}\right) \otimes I^{APB}\left(d^{*}\right) \otimes I^{C}\left(d^{*}\right) \otimes I^{GRS}\left(d^{*}\right) \dots$

Contributions can be separated by means of a FOURIER ANALYSIS:

the Fourier Transform (FT) of $I(d^*)$ is the product of the FTs of the single profile components

Traditional Fourier methods (e.g. Warren-Averbach): (a) background subtraction and deconvolution of the instrumental component; (b) analysis of single peak profiles



 $(L = n d_{hkl})$

WARREN-AVERBACH METHOD

After the background has been subtracted and the instrumental profile (IP) component deconvoluted, the Fourier Transform of the diffraction peak profile is:

$$I(d^*) = k(d^*) \int A_L e^{2piLd^*} dL$$

Fourier coefficients $A_L = A_L^S \cdot A_L^D$
for size (S) and strain (D) effects

According to the Warren-Averbach method (l_o is the diffraction order):

$$\ln(A_L)$$
; $\ln(A_L^S) - 2p^2 L^2 \langle e_{hkl}^2(L) \rangle l_0^2 / d_{hkl}^2$

'Size' and 'strain terms can be separated by means of a plot of $ln(A_L)$ as a function of $l_0^2 d_{hkl}^{*2} = l_0^2 / d_{hkl}^2$, for different values of L.



WARREN-AVERBACH METHOD



Plot ln(A_L) as a function of $l_0^2 d_{hkl}^{*2} = l_0^2 / d_{hkl'}^2$ for different vaues of L.



WARREN-AVERBACH METHOD

Provided that the procedure has been carried out properly (calculate Fourier Coefficients, account for background, instrumental component and peak overlapping, presence of faulting, other defects, etc.) ...

• Size Fourier coefficients: A_L^S

(to be related to the column length distribution, $p(L) \propto d^2 A_L^S / dL^2$)

For example, for a spherical crystallite:



• Microstrain: $\langle e_{hkl}^2(L) \rangle$ (to be related to the strain distribution $p(e_{hkl}(L))$ generated by the specific source of lattice strain)

... interpretation of W-A results is not straightforward

PROFILE FITTING AND LINE PROFILE ANALYSIS

Traditional methods are generally grouped as:

- 'Simplified' methods based on the integral breadth (e.g., *Scherrer* formula, *Williamson-Hall* plot)
- Fourier Methods (e.g., *Warren-Averbach* method)

The practical application of these methods requires the extraction of profile data from the experimental pattern. To this purpose it is nowadays a common practice to use:

Pattern decomposition + Line Profile Analysis



Scherrer formula, *WH* plot, *Warren-Averbach* method

PROFILE FITTING AND LINE PROFILE ANALYSIS

Pattern decomposition by profile fitting (e.g. by MarqX) is used to extract peak profile parameters. The method employs analytical profile functions (e.g., Voigt, pV, PVII). It is a practical and flexible approach, even if it is arbitrary in that it imposes an a-priori shape to the profiles.





PROFILE FITTING + WILLIAMSON-HALL METHOD



Ceria-stabilized zirconia with 20% standard Silicon (SRM 640b).

Whole Powder Pattern Fitting (WPPF) by *MarqX*.

Williamson-Hall analysis results: 1/intercept à D~230 Å,

slope à e~0.0027



Y.H. Dong & P. Scardi, J. Applied Crystallography 33 (2000) 184-189.

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PROFILE FITTING + WARREN-AVERBACH METHOD



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PROFILE FITTING + WARREN-AVERBACH METHOD





DIFFRACTION LINE BROADENING

Advanced methods: Whole Powder Pattern Modelling (WPPM)

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Traditional Line Profile Analysis

Most traditional methods are based on a multiple-step procedure:

- 1. Correction of line profiles for the instrumental component/backgr.
- 2. Extraction of line profile data (FWHM, β , Fourier coefficients, ...), typically by analytical profile fitting
- 3. Application of physical models to parameters *extracted* from the experimental pattern.



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Whole Powder Pattern Modelling

WPPM is based on a direct modelling of the experimental pattern, based on physical models of the microstructure and lattice defects:



Diffraction line profile: a convolution of effects

The Whole Powder Patten Modelling follows a Fourier analysis (like e.g. the Warren-Averbach method) but adopts a *convolutive approach*

$$I(d^*) = I^{IP}(d^*) \otimes I^S(d^*) \otimes I^D(d^*) \otimes I^F(d^*) \otimes I^{APB}(d^*) \otimes I^C(d^*) \otimes I^{GRS}(d^*) \dots$$

the Fourier Transform of I(s) is the product of the FTs of the single profile components

$$I(d^*) \propto \cdot \int \mathbf{\hat{f}} (L) e^{2p i L \cdot s_{hkl}} dL$$

 $-\infty$

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DIFFRACTION LINE BROADENING

Whole Powder Pattern Modelling (WPPM) Applications

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WPPM application: nanocrystalline Ceria Nanocrystalline cerium oxide from sol-gel route





WPPM application: nanocrystalline Ceria Nanocrystalline cerium oxide from sol-gel route





Planetary ball milling







SR XRD - ball milled Fe 1.5Mo

Fe1.5Mo powder ball-milled for 96 hours in a Fritsch P4 planetary mill



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SR XRD - ball milled Fe 1.5Mo

Ball-milled Fe1.5Mo: dislocation density/domain size vs. morphology



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SR XRD - ball milled Fe 1.5Mo

In addition to mean sizes, WPPM provides the distributions:



P. Scardi in "Powder Diffraction. Theory and practice". Eds: R. E. Dinnebier & S. Billinge. The Royal Society of Chemistry, 2006. In press. ICTP School - Trieste, May 2006 - © Do not copy – Do not reproduce 48



ball milled Fluorite

Effect of domain size and defectivity on the solubility of fluorite (ionic product)



0 h b.m.



32 h b.m. G. De Giudici et al. *Geochim. Cosmochim. Acta* 29 (2005) 4073

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ball milled Fluorite





APDs in Cu₃Au

Anti Phase Domains form during the ordering process in Cu_3Au . The o/d process can be thermally activated





APDs in Cu₃Au







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Software MarqX, PM2K: <u>Paolo.Scardi@unitn.it</u> <u>Matteo.Leoni@unitn.it</u>



MCX - A new beamline for Materials Characterization by XRD at ELETTRA (Trieste, Italy) A. Lausi (Sincrotrone Trieste), P.Scardi (Univ. Trento & INSTM)



Examples of typical applications

- Residual stress and texture analysis in thin films by multiple wavelength XRD
- Surface analysis by grazing incidence XRD and reflectivity
- Medium-low energy (3.5÷20 keV) anomalous scattering XRD
- Line Profile Analysis (e.g., nanocrystalline, highly defected materials)
- Non-ambient studies (controlled atmosphere, high temperature kinetics)
- Surface mapping by microdiffraction (diffraction on small area)